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The document following this cover page is marked as “Cypress” document as this is the company that originally developed the product. Please note that Infineon will continue to offer the product to new and existing customers as part of the Infineon product portfolio.

Continuity of document content

The fact that Infineon offers the following product as part of the Infineon product portfolio does not lead to any changes to this document. Future revisions will occur when appropriate, and any changes will be set out on the document history page.

Continuity of ordering part numbers

Infineon continues to support existing part numbers. Please continue to use the ordering part numbers listed in the datasheet for ordering.

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REVISIONS						
PAGE	ZONE	REV	ECN	DESCRIPTION	DATE	APPROVED
ALL	-	**	109470	NEW RELEASE	08/21/01	N/A
ALL	-	*A	111367	REMOVE CAVITY DIM./ CHG. PKG. BODY DIM. TO MIN./MAX.	11/05/01	N/A
ALL	-	*B	117574	REMOVE DETAIL MARK AT 4 CORNERS BTM VIEW/ CHG. PIN 1 ID AT BTM VIEW.	07/24/02	N/A
ALL	-	*C	125371	ADD PKG. OPTION 2/CHG. ALL DIM.S TO MIN./MAX. AND MM[INCHES] /ADD JEDEC NOTE.	03/14/03	N/A
ALL	-	*D	127105	DELETE PKG. OPTION 2/ CHG. TITLE/ CHG. PART # ADD E-PAD NOTE	05/19/03	N/A
ALL	-	*E	489049	ADD U-GROOVE OPTION FOR CML BUILD	07/28/06	N/A
ALL	-	*F	514860	CORRECT REVISION "E" ECN NUMBER FROM 489772 TO 489049	10/12/06	N/A
ALL	-	*G	736321	REVISED DRAWING, DEFINED SOLDERABLE EXPOSED AREA. REMOVED CML OPTION. CHANGED SPEC. TITLE, CORRECTED EPAD DIMENSION	01/29/07	JSO
ALL	-	*H	2813378	Changed Template and Title from 56LD QFN 8 X 8mm PACKAGE OUTLINE (SUBCON PUNCH TYPE PKG with 6.1 x 6.1 EPAD) to PACKAGE OUTLINE, 56LD QFN 8X8X1.0 MM LF56/LY56 6.1X6.1 EPAD (SUBCON PUNCH TYPE).	11/24/09	QAD
ALL	-	*I	3159033	NO CHANGE	02/01/11	QAD
ALL	-	*J	4584955	Sunset Review, Changed drawing template.	12/02/14	QAD

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TITLE PACKAGE OUTLINE, 56LD QFN 8X8X1.0 MM LF56/LY56 6.1X6.1 EPAD (SUBCON PUNCH TYPE))			
SPEC NO.		51-85144	REV *J
SCALE		SHEET 2 of 2	

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PACKAGE CODE(S)

LF56
LY56

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